

MiWiTM Demo Kit User's Guide

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Table of Contents

Preface	5
Chapter 1. Overview	
1.1 MiWi™ Demo Kit Contents	9
1.2 MiWi™ Demo Kit	9
Chapter 2. MiWi™ Demo Board	
2.1 MiWi™ Board Layout and Features	11
Chapter 3. Getting Started	
3.1 Hardware Requirements	15
3.2 Demo Setup	15
3.3 Preprogrammed Tutorial Operation	15
Appendix A. MiWi™ Demo Board Schematics	
A.1 Introduction	19
A.2 MiWi™ Demo Board Schematics	19
A.3 MiWi™ Demo Board PCB Layout	23
A.4 MiWi™ Demo Board Bill of Materials (BOM)	29
Index	31
Worldwide Sales and Service	32

NOTES:		



Preface

NOTICE TO CUSTOMERS

All documentation becomes dated, and this manual is no exception. Microchip tools and documentation are constantly evolving to meet customer needs, so some actual dialogs and/or tool descriptions may differ from those in this document. Please refer to our web site (www.microchip.com) to obtain the latest documentation available.

Documents are identified with a "DS" number. This number is located on the bottom of each page, in front of the page number. The numbering convention for the DS number is "DSXXXXXA", where "XXXXXX" is the document number and "A" is the revision level of the document.

For the most up-to-date information on development tools, see the MPLAB[®] IDE online help. Select the Help menu, and then Topics to open a list of available online help files.

INTRODUCTION

This chapter contains general information that will be useful to know before using the MiWi™ Demo Kit User's Guide. Items discussed in this chapter include:

- Document Lavout
- · Conventions Used in this Guide
- Warranty Registration
- · Recommended Reading
- The Microchip Web Site
- Development Systems Customer Change Notification Service
- Customer Support

DOCUMENT LAYOUT

This user's guide describes how to use the MiWi Demo Kit to evaluate and experiment the Microchip Wireless Solutions. This user's guide consists of the following chapters:

- Chapter 1. "Overview" This chapter describes the MiWi Demo Kit and how it works.
- Chapter 2. "MiWi™ Demo Board" This chapter details the hardware information
 of the MiWi Demo Board.
- Chapter 3. "Getting Started" This chapter describes what you need to know to start using the MiWi Demo Kit.
- Appendix A. "MiWi™ Demo Board Schematics" This appendix illustrates the PCB layout and BOM, and it also includes MiWi Demo Board schematics.

CONVENTIONS USED IN THIS GUIDE

This manual uses the following documentation conventions:

DOCUMENTATION CONVENTIONS

Description	Represents	Examples
Arial font:		
Italic characters	Referenced books	MPLAB [®] IDE User's Guide
	Emphasized text	is the only compiler
Initial caps	A window	the Output window
	A dialog	the Settings dialog
	A menu selection	select Enable Programmer
Quotes	A field name in a window or dialog	"Save project before build"
Underlined, italic text with right angle bracket	A menu path	<u>File>Save</u>
Bold characters	A dialog button	Click OK
	A tab	Click the Power tab
Text in angle brackets < >	A key on the keyboard	Press <enter>, <f1></f1></enter>
Courier New font:		
Plain Courier New	Sample source code	#define START
	Filenames	autoexec.bat
	File paths	C:\mcc18\h
	Keywords	_asm, _endasm, static
	Command-line options	-Opa+, -Opa-
	Bit values	0, 1
	Constants (in source code)	0xFF, 'A'
Italic Courier New	A variable argument	file.o, where file can be any valid filename
Square brackets []	Optional arguments	mcc18 [options] file [options]
Curly brackets and pipe character: { }	Choice of mutually exclusive arguments; an OR selection	errorlevel {0 1}
Ellipses	Replaces repeated text	var_name [, var_name]
	Represents code supplied by user	<pre>void main (void) { }</pre>

WARRANTY REGISTRATION

Please complete the enclosed Warranty Registration Card and mail it promptly. Sending in the Warranty Registration Card entitles users to receive new product updates. Interim software releases are available at the Microchip web site.

RECOMMENDED READING

This user's guide describes how to use the ZENA Wireless Adapter. The following Microchip documents are available from the Microchip web site (http://www.microchip.com), and are recommended as supplemental reference resources.

- "MRF24J40MA 2.4 GHz IEEE Std. 802.15.4 RF Transceiver Module" (DS70329)
- "MRF89XAM8A Data Sheet 868 MHz Ultra-Low Power Sub-GHz Transceiver Module" (DS70651)
- "MRF89XAM9A Data Sheet 915 MHz Ultra-Low Power Sub-GHz Transceiver Module" (DS75017)
- "PIC18F46J50 USB Microcontroller Data Sheet" (DS39931)
- "2K SPI Bus Serial EEPROM with EUI-48TM Node Identity Data Sheet" (DS22123)
- "1 Mbit SPI Serial Flash SST25VF010A" (S725081)
- "MCP9700A/01A Low Power Linear Active Thermistor ICs" (DS21942)

THE MICROCHIP WEB SITE

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- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip consultant program member listings
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listings of seminars and events; and listings of Microchip sales offices, distributors and factory representatives

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The Development Systems product group categories are:

- Compilers The latest information on Microchip C compilers and other language tools. These include the MPLAB C18 and MPLAB C30 C compilers; MPASM[™] and MPLAB ASM30 assemblers; MPLINK[™] and MPLAB LINK30 object linkers; and MPLIB[™] and MPLAB LIB30 object librarians.
- **Emulators** The latest information on Microchip in-circuit emulators. This includes the MPLAB ICE 2000 and MPLAB ICE 4000.
- In-Circuit Debuggers The latest information on the Microchip in-circuit debugger, MPLAB ICD 2.
- MPLAB IDE The latest information on Microchip MPLAB IDE, the Windows[®]
 Integrated Development Environment for development systems tools. This list is focused on the MPLAB IDE, MPLAB SIM simulator, MPLAB IDE Project Manager and general editing and debugging features.
- Programmers The latest information on Microchip programmers. These include the MPLAB PM3 and PRO MATE[®] II device programmers and the PICSTART[®] Plus and PICkit™ 1 development programmers.

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- · Distributor or Representative
- · Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative, or FAE for support. Local sales offices are also available to help customers. A list of sales offices and locations is included in the back of this document.

Technical support is available through our web site at http://support.microchip.com.

DOCUMENT REVISION HISTORY

Revision A (September 2012)

This is the initial released version of the document.



Chapter 1. Overview

This chapter introduces the MiWi™ Demo Kit features and its requirements. The topic covered includes:

- MiWi™ Demo Kit Contents
- MiWi™ Demo Kit

1.1 MiWi™ DEMO KIT CONTENTS

Based on the frequency of operation selected, the MiWi Demo Kit contains any one of the following items:

- Two MiWi Demo Boards with PIC18F46J50 XLP Microcontroller with MRF24J40 MA Module
- Two MiWi Demo Boards with PIC18F46J50 XLP Microcontroller with MRF89XAM8A Module
- Two MiWi Demo Boards with PIC18F46J50 XLP Microcontroller with MRF89XAM9A Module

1.2 MiWi™ DEMO KIT

The MiWi Demo Kit enables developers to evaluate and experiment with 2.4 GHz, 868 MHz and 915 MHz RF solutions from Microchip. The MiWi Demo Kit contains two hardware nodes (MiWi Demo Boards) which can be used to create a simple two node MiWi wireless network. More hardware nodes to the same network can be added by purchasing additional MiWi Demo Kits or individual components.

The MiWi Demo Kit is preprogrammed with a wireless demo program that enables users to setup a MiWi network easily. For more information on running the preprogrammed demo program and extending the network refer to **Chapter 3."Getting Started"**. The Microchip wireless stacks and additional application demo source codes can be downloaded from the Microchip web site http://www.microchip.com/wireless.

NOTES:



Chapter 2. MiWiTM Demo Board

This chapter describes the MiWi Demo Board hardware and the topic covers MiWi™ Board Layout and Features.

2.1 MiWi™ BOARD LAYOUT AND FEATURES

This section describes the MiWi Demo Board hardware, which also features key components shown in Figure 2-1 and Figure 2-2.

FIGURE 2-1: MiWi™ DEMO BOARD (FRONT VIEW)

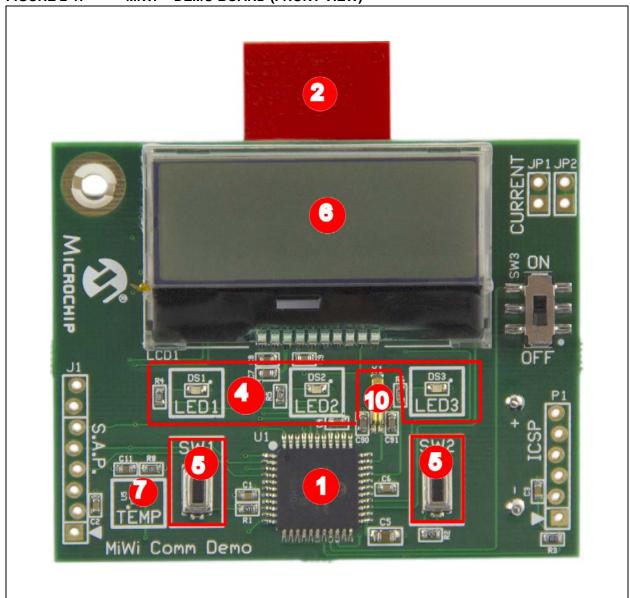
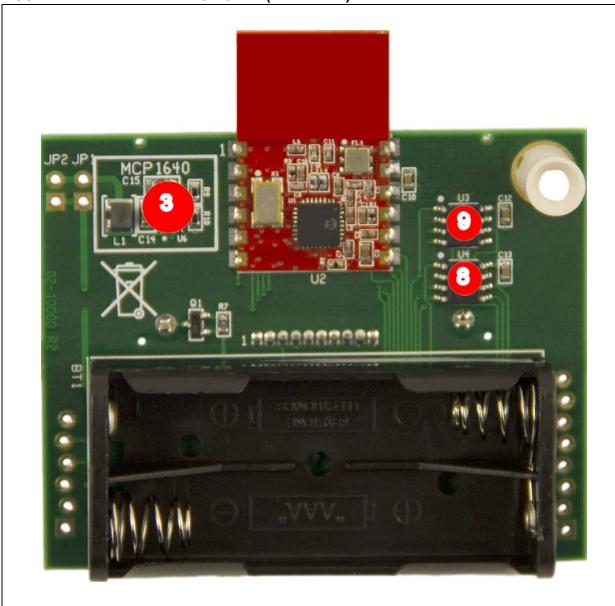


FIGURE 2-2: MiWi™ DEMO BOARD (REAR VIEW)



This MiWi Demo board includes these key features, as indicated in the Figure 2-1 and Figure 2-2.

- 1. PIC18F46J50 8-bit XLP microcontroller
- 2. MRF24J40MA RF Transceiver Module or MRF89XAM8A RF Transceiver Module or MRF89XAM9A RF Transceiver Module
- 3. +3.3V Boost Regulator (MCP1640)
- 4. Three status indicator LEDs (Red, Yellow and Green)
- 5. Two push-button switches (SW1 and SW2) for user input
- 6. 2 X 16 LCD Character Display
- 7. MCP9700 Temperature Sensor
- 8. 2K SPI EEPROM with a unique MAC Address
- 9. 1 Mbit SPI Serial Flash
- 10. 32 KHz Crystal for Sleep Mode

Some of main blocks defined on the board are explained in detail below:

2.1.1 PIC18F46J50 Microcontroller

PIC18F46J50 microcontroller is an 8-bit XLP 44-pin microcontroller with 64K program memory.

2.1.2 RF Transceiver Module

MiWi Demo board supports MRF24J40MA, MRF89XAM8A, MRF89XAM9A RF transceiver modules. It has dedicated SPI Interface and interrupt lines between the microcontroller and the RF transceiver module.

2.1.3 Status Indicator LEDs

To indicate the status the MiWi Demo board has three LEDs: LED1(green), LED2 (yellow), and LED3 (red).

2.1.4 Push Buttons

MiWi Demo board contains two push buttons SW1 and SW2. These push buttons are assigned to the individual interrupt lines of the microcontroller. The user software must enable Port B pull-ups of the microcontroller before evaluating the push button state. Example 2-1 provides a possible solution to evaluate the state of SW1 push button.

EXAMPLE 2-1: CODE EXAMPLE FOR EVALUATING THE STATE OF SW1

```
// Initialize RB1 - SW1
TRISBbits.TRISB2 = 1;// RB1 is an input
ANCON1 = ANCON1 | 0x04;// RB1 is a digital pin
/*
User Code
*/
//Evaluating RB1
INTCON2bits.RBPU = 0;// Enable PORT B pull-ups for switches
If (PORTBbits.RB1 = 0 )// RB1 pushed
{
   /*
RB1/SW1 push button code
*/
}
INTCON2bits.RBPU = 1;//PORTB pull-ups disabled
```

2.1.5 LCD Character Display

The LCD supports power saving modes. The LCD has a backlight display which can be turned on or off based on the power consumption and it supports 32 characters in two lines (16 characters in each line). It uses shared SPI interface (with SPI EEPROM and SPI Serial Flash) to communicate with the microcontroller.

2.1.6 Temperature Sensor

The temperature sensor (MCP9700A) is a low-power Linear Active Thermistor IC. To minimize power consumption, the sensor is powered from a port pin. After powering up, the sensor output can be measured after a minute. The internal AD converter of the microcontroller can be used to measure the temperature value.

2.1.7 EEPROM with MAC Address

The Serial EEPROM is a low-power, Microchip 25LC256 256K SPI Bus Serial EEPROM, it uses shared SPI interface with SPI Serial Flash and LCD.

2.1.8 SPI Serial Flash

MiWi Demo board features a 1Mb SPI Serial Flash for storing and retrieving network or any application specific information. The SPI Serial Flash and Serial EEPROM share the SPI bus and each has its own active low-chip select.

2.1.9 Power Supply

The MiWi Demo board uses two AAA batteries for power supply. Current consumption for the entire board can also be measured at JP1 and JP2 without disturbing it.

2.1.10 +3.3V Boost Regulator

The MCP1640 is a compact, high efficiency boost regulator. It ensures that the voltage requirements for the RF transceivers are met throughout the lifetime of the battery.



Chapter 3. Getting Started

This chapter is a self paced tutorial to use the MiWiTM Demo Board. It explains in detail how to run the preprogrammed demo. The source code for the demo is available along with the MiWi stack (latest version of Microchip Applications library is available at http://www.microchip.com/MAL). After unzipping the latest version of MiWi stack, the default location for MiWi Demo Kit Out of Box Demo is "C:\Microchip Solutions\MiWi DE Demo\MiWi Demo Kit\".

For more information about MiWi stack, refer to http://www.microchip.com/MiWi.

Topics covered include:

- Hardware Requirements
- Demo Setup
- Preprogrammed Tutorial Operation

3.1 HARDWARE REQUIREMENTS

The following hardware is required to run the preprogrammed demo application:

- Two MiWi Demo Boards
- · Four AAA batteries for powering up the boards

3.2 DEMO SETUP

The MiWi Demo Board comes with a preprogrammed Demo Board. Follow these steps to set up the demo:

- 1. Plug in two AAA batteries on each MiWi Demo Board.
- 2. To power up the board, move SW3 switch from "OFF" position to the "ON" position. On powering, a splash screen will be displayed on the LCD screen.

3.3 PREPROGRAMMED TUTORIAL OPERATION

1. On powering the boards, the following splash screen message will be displayed on the LCD screen for 2 seconds.

"Microchip

MiWi Demo Board"

2. The display changes to channel selection screen. Choose the channel to setup the network.

"SW1: <Sel Ch: 26> SW2: Chnge Chnl"

Press SW1 push button to select channel 26 as the operating channel or press SW2 push button to choose a different channel. For MRF24J40 Channel 11 through channel 26 are available. Using the push buttons on the board, the user can choose operating channel from channel 11 through channel 26. For MRF89XA channel 0 through channel 31 are available.

Note: Ensure that you select same operating channel on both the MiWi Demo Boards to enable connection with each other.

3. The LCD screen displays network setup options:

"SW1: Create Ntwk SW2: Join Ntwk"

4. Press SW1 push button on one of the boards to create a MiWi network (PAN Coordinator) with a random PANID. After the network is created, the board will notify the user that the network is created successfully, and then display the node information such as PAN ID, Channel and Address until a node joins.

"PANID: 1234 Ch: 26 Address: 0000"

Press SW2 push button on the second board to join a MiWi network. The board performs a scan of nearby networks and allows the user to choose the network to join to.

"SW1: < PANID:1234>
SW2: Additional"

6. Press SW1 push button on the second board after choosing the network (PANID) to connect.

Note: If more than one node from the same network (PANID) has responded with a beacon, the user can select the node to join by using the network short address information printed on the LCD. Use SW1 and SW2 to choose the node to establish connection with in a network similar to PANID.

 After the second board is joined the network, the user has the option to run any one of the these demo applications: Range Demo, Temp Demo, Node Info. The LCD screen displays this message.

> "SW1: Range Demo SW2: Other Apps"

The current Out of Box demo for MiWi Demo Kit supports all the three Range Demo, Temp Demo and Node Info applications.

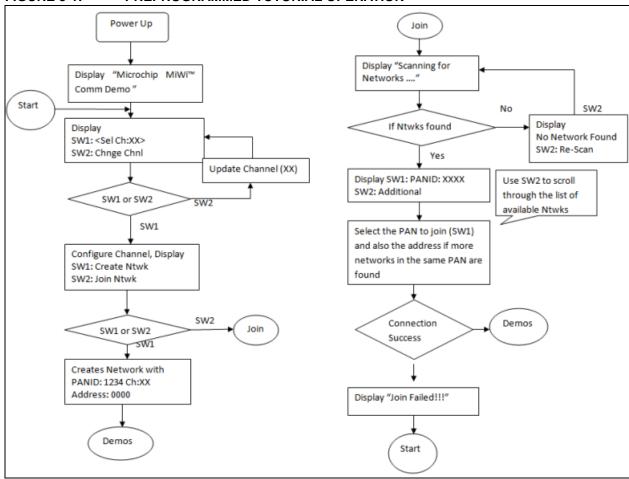
- a) Range Demo is used to demonstrate the range of Microchip's MRF24J40MA and MRF89XA transceiver. It performs a range test by transmitting a packet to the remote node and displaying the Received Signal Strength Indication (RSSI) value on the LCD Display. The display will show this RSSI value after each packet is received and will notify the user the strength of the signal such as, high, medium, low, or out of range.
- b) The Temp Demo uses on-board Microchip's MCP9700A temperature sensor (Low-Power Linear Active Thermistor IC). This demo measures the temperature and displays its local temperature information in C (Celsius) and F (Fahrenheit) on the display and broadcast its reading to other nodes listening. If other nodes are connected it will then cycle through each remote node's reading.

c) In the node Info, the node's PANID and Address information will be displayed on the LCD screen.

"PANID: 1234 Ch: 26 Address: 0000"

Figure 3-1 illustrates the preprogrammed tutorial operation.

FIGURE 3-1: PREPROGRAMMED TUTORIAL OPERATION



NOTES:



Appendix A. MiWiTM Demo Board Schematics

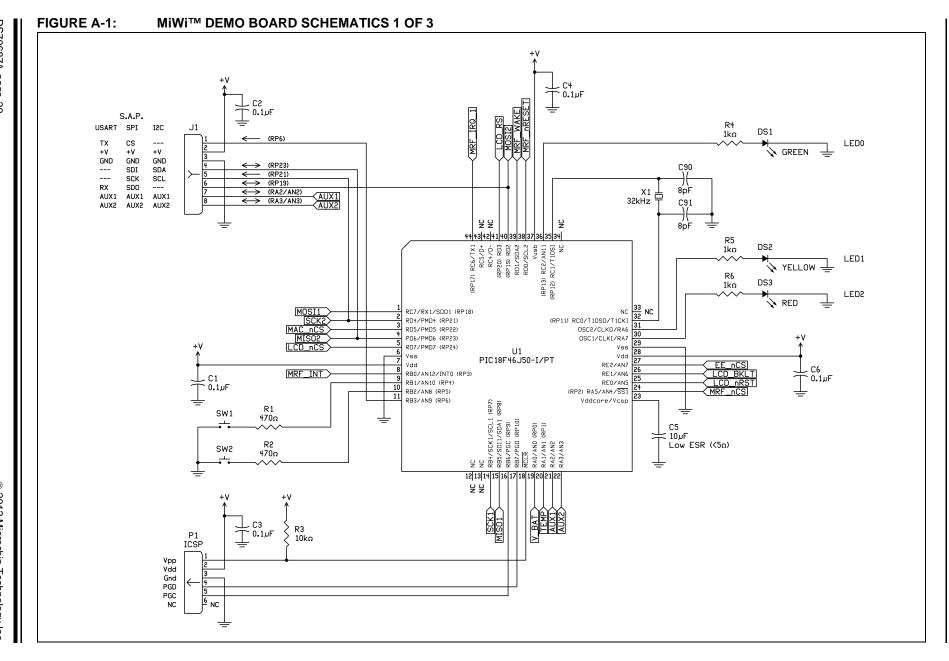
A.1 INTRODUCTION

This appendix includes:

- MiWi™ Demo Board Schematics
- MiWi™ Demo Board PCB Layout
- MiWi™ Demo Board Bill of Materials (BOM)

A.2 MiWi™ DEMO BOARD SCHEMATICS

Figure A-1, Figure A-2 and Figure A-3 illustrate the MiWi Demo Board schematics.



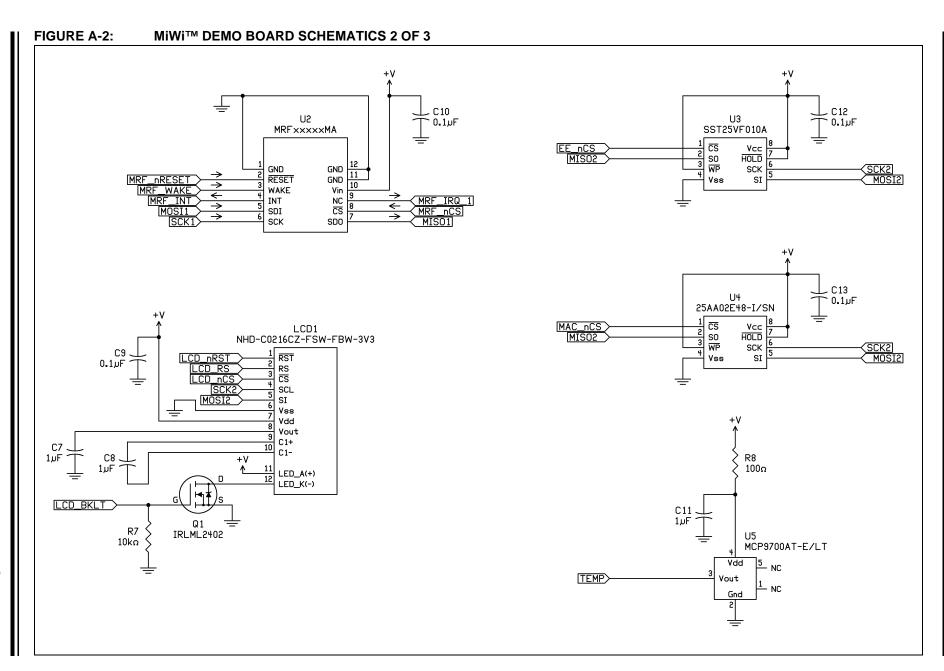
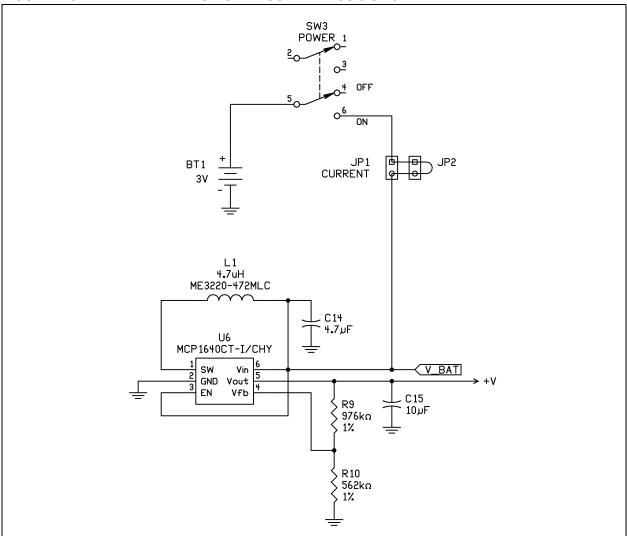


FIGURE A-3: MiWi™ DEMO BOARD SCHEMATICS 3 OF 3



A.3 MiWi™ DEMO BOARD PCB LAYOUT

The MiWi Demo PCB is a 4-layer, high temperature FR4, 0.062 inch, plated through hole construction. Figure A-4 through Figure A-9 illustrate the PCB layers.

FIGURE A-4: PCB TOP SILKSCREEN

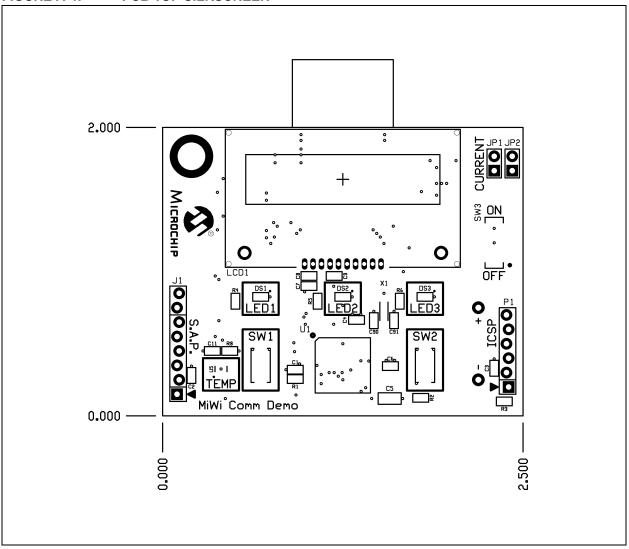


FIGURE A-5: **PCB TOP COPPER** 2.000 -0.000

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FIGURE A-7: **PCB BOTTOM COPPER** 2.000 -000000 0.000

FIGURE A-8: **PCB INNER LAYER 2 POWER**

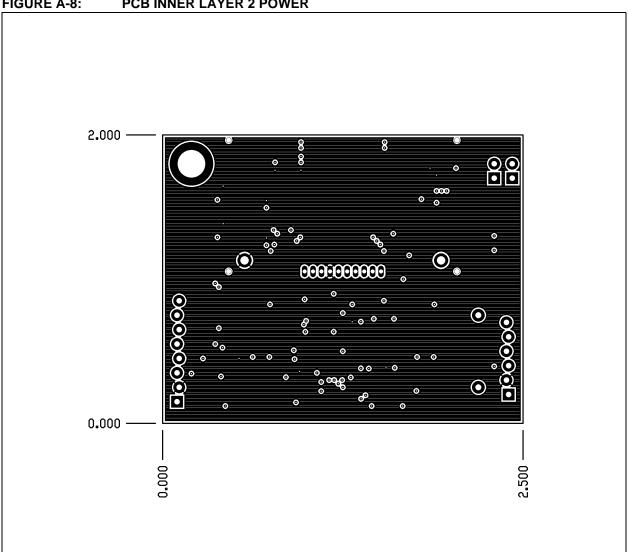


FIGURE A-9: **PCB INNER LAYER 3 GROUND** 2.000 -0 0 0000000000 0 0 00 0 0.000

A.4 MiWi™ DEMO BOARD BILL OF MATERIALS (BOM)

FIGURE A-10: MiWi™ DEMO BOARD BILL OF MATERIALS (BOM)

C10, C1 C10, C1 C10, C1 C14 C14 C14 C14 C15 C5, C15 C1 DS3 C5, C15 C1 DS3 C1 L1 CD1 CD1 CD1 CD1 CD1 CD1 CD1 C	C91 C2, C3, C4, C6, C9, C12, C13	— 8 pF	HOLDER BATTERY 2CELL AAA PC MNT	Keystone Electronics	2468
9 C1, C2 C10, C1 3 C7, C8, 1 C14 3 C5, C15 1 DS1 1 DS2 1 DS3 1 L1 1 LCD1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz	C2, C3, C4, C6, C9,	8 pF			2.100
C10, C1 C10, C1 C10, C1 C7, C8, C7, C8, C10, C15 C10, C16 C			Capacitor, Ceramic, 50V, +/-0.5pF, C0G, SMT 0603	Murata Electronics North America	GRM1885C1H8R0DZ 01D
1 C14 3 C5, C15 1 DS1 1 DS2 1 DS3 1 L1 1 LCD1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		0.1 uF	Capacitor, Ceramic, 16V, +/-10%, X7R, SMT 0603	Murata Electronics North America	GRM188R71C104KA0 1D
3 C5, C15 1 DS1 1 DS2 1 DS3 1 L1 1 LCD1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz	C8, C11	1 uF	Capacitor, Ceramic, 6.3V, +/-10%, X5R, SMT 0603	Murata Electronics North America	GRM188R60J105KA0 1D
1 DS1 1 DS2 1 DS3 1 L1 1 LCD1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		4.7 uF	Capacitor, Ceramic, 6.3V, +/-20%, X5R, SMT 0805	Murata Electronics North America	GRM219R60J475ME0 1D
1 DS2 1 DS3 1 L1 1 LCD1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz	C15	10 uF	Capacitor, Ceramic, 6.3V, +/-20%, X5R, SMT 0805	Murata Electronics North America	GRM21BR60J106ME1 9L
1 DS3 1 L1 1 LCD1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		Green	Diode, Light Emitting	OSRAM	LG Q971-KN-1-0-20-R18
1 L1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		Yellow	Diode, Light Emitting	OSRAM	LY Q976-P1S2-36
1 LCD1 1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		Red	Diode, Light Emitting	OSRAM	LS Q976-NR-1-0-20-R18
1 Q1 1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		4.7 uH	Inductor	Coilcraft	ME3220-472ML_
1 R8 2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz	1	_	LCD, 2x16 character	Newhaven Display Intl	NHD-C0216CZ-FSW- FBW-3V3
2 R1, R2 3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz			MOSFET N-CH 20V 1.2A SOT-23	IRLML2402	International Rectifier
3 R4, R5, 2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		100 ohms	Resistor, Thin Film, 5%, SMT 0603	Yageo	RC0603JR-07100RL
2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz	₹2	470 ohms	Resistor, Thin Film, 5%, SMT 0603	Yageo	RC0603JR-07470RL
2 R3, R7 1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz	R5. R6	1K ohms	Resistor, Thin Film, 5%, SMT 0603	Yageo	RC0603JR-071KL
1 R10 1 R9 2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		10K ohms	Resistor, Thin Film, 5%, SMT 0603	Yageo	RC0603JR-0710KL
2 SW1, S' 1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		562K ohms	Resistor, Thin Film, 1%, SMT 0603	Yageo	RC0603FR-07562KL
1 SW3 1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		976K ohms	Resistor, Thin Film, 1%, SMT 0603	Yageo	RC0603FR-07976KL
1 U4 1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz	, SW2	_	Switch, Pushbutton, Momentary, 6x3mm SMT	C&K Components	PTS635SL25SMTR LFS
1 U6 1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		_	Switch, Slide DPDT, 6VDC, 0.3A, SMT	C&K Components	JS202011SCQN
1 U5 1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz			25AA02E48-I/SN	Microchip Technology	25AA02E48-I/SN
1 U1 1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		_	MCP1640CT-I/CH	Microchip Technology	MCP1640CT-I/CH
1 U3 1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz			MCP9700A	Microchip Technology	MCP9700AT-E/LT
1 X1 1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz			PIC18F46J50-I/PT	Microchip Technology	PIC18F46J50-I/PT
1 Stand C 868 MH 1 U2 915 MH 1 U2 2.4 GHz		_	SST25VF010A	Microchip Technology	SST25VF010A-33-4C- SAE
868 MH 1 U2 915 MH 1 U2 2.4 GHz		_	Crystal, 32.768 kHz, 9 pF, +/- 20 ppm, SMT	Micro Crystal	MS3V-T1R 32.768kHz +-20 ppm 9 pF
1 U2 915 MH 1 U2 2.4 GHz	d Off	_	Stacking Spacer, 0.500 inch height	Keystone Electronics	8833
915 MH 1 U2 2.4 GHz	MHz Version (DM18201	6-2)			
1 U2 2.4 GHz			MRF89XAM8A-I/RM	Microchip Technology	MRF89XAM8A-I/RM
1 U2 2.4 GHz	MHz Version (DM18201	6-3)	ı	<u>'</u>	<u> </u>
2.4 GHz	· · · · · · · · · · · · · · · · · · ·		MRF89XAM9A-I/RM	Microchip Technology	MRF89XAM9A-I/RM
-	GHz Version (DM182016	-1)		<u> </u>	I
1 102	,	-	MRF24J40MA-I/RM	Microchip Technology	MRF24J40MA-I/RM
-	arate Bag		<u> </u>	1	<u> </u>
1 J1			Socket, Right Angle, 6 pin, 0.100 inch spacing	Samtec	SSW-106-02-G-S-RA
1 P1			Header, Right Angle, 6 pin, 0.100 inch spacing	Samtec	TSW-106-08-T-S-RA
Do Not	lot Populate		[-F/8		<u> </u>
1 JP1, JP			Connector, Header, 2-pin, 0.100" spacing	SPC Technology	SPC20481

NOTES:



Index

В
Block Diagrams High-level23
С
Customer Change Notification Service 7 Customer Support 7
D
Documentation Conventions
I
Internet Address 6
M
Microchip Internet Web Site6
R
Readme6
S
Schematics Solomon Systech SSD1926 LCD Controller 29
W
WWW Address 6



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